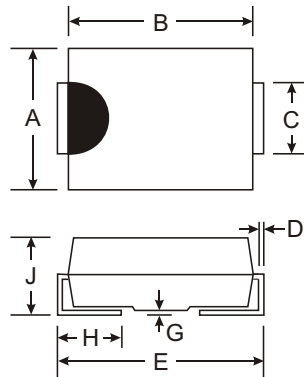


Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automatic Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 30A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- High Temperature Soldering: 260°C/10 Second at Terminal
- Available in Lead Free Version

Mechanical Data

- Case: SMA / SMB, Molded Plastic
- Plastic Material: UL Flammability Classification Rating 94V-0
- Moisture sensitivity: Level 1 per J-STD-020A
- Terminals: Solder Plated Terminal - Solderable per MIL-STD-202, Method 208
- Also Available in Lead Free Plating (Matte Tin Finish). Please See Ordering Information, Note 4, on Page 2
- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.064 grams (approx.)
- SMB Weight: 0.093 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



Dim	SMA		SMB	
	Min	Max	Min	Max
A	2.29	2.92	3.30	3.94
B	4.00	4.60	4.06	4.57
C	1.27	1.63	1.96	2.21
D	0.15	0.31	0.15	0.31
E	4.80	5.59	5.00	5.59
G	0.10	0.20	0.10	0.20
H	0.76	1.52	0.76	1.52
J	2.01	2.62	2.00	2.62
All Dimensions in mm				

No Suffix Designates SMA Package
 "B" Suffix Designates SMB Package

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	B170/B	B180/B	B190/B	B1100/B	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	70	80	90	100	V
Working Peak Reverse Voltage	V _{RWM}					
DC Blocking Voltage	V _R					
RMS Reverse Voltage	V _{R(RMS)}	49	56	63	70	V
Average Rectified Output Current @ T _T = 125°C	I _O	1.0				A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	30				A
Forward Voltage @ I _F = 1.0A @ T _A = 25°C @ T _A = 100°C	V _{FM}	0.79 0.69				V
Peak Reverse Current at Rated DC Blocking Voltage @ T _A = 25°C @ T _A = 100°C	I _{RM}	0.5 5.0				mA
Typical Junction Capacitance (Note 2)	C _j	80				pF
Typical Thermal Resistance Junction to Terminal (Note 1)	R _{θJT}	25				K/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150				°C

Notes: 1. Valid provided that terminals are kept at ambient temperature.
 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

Ordering Information (Note 3 & 4)

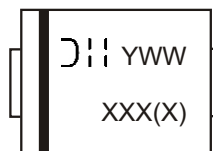
Device*	Packaging	Shipping
B1x-13 B1xB-13	SMA SMB	5000/Tape & Reel 3000/Tape & Reel

Notes: 3. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

* x = Device type, e.g. B180-13 (SMA package); B1100B-13 (SMB package).

4. For lead free terminal plating part number, please add "-F" suffix to part number above. Example: B170-13-F.

Marking Information



XXX = Product type marking code, ex: B170 (SMA package)
 XXXX = Product type marking code, ex: B190B (SMB package)
 ␣␣␣ = Manufacturers' code marking
 YWW = Date code marking
 Y = Last digit of year ex: 2 for 2002
 WW = Week code 01 to 52

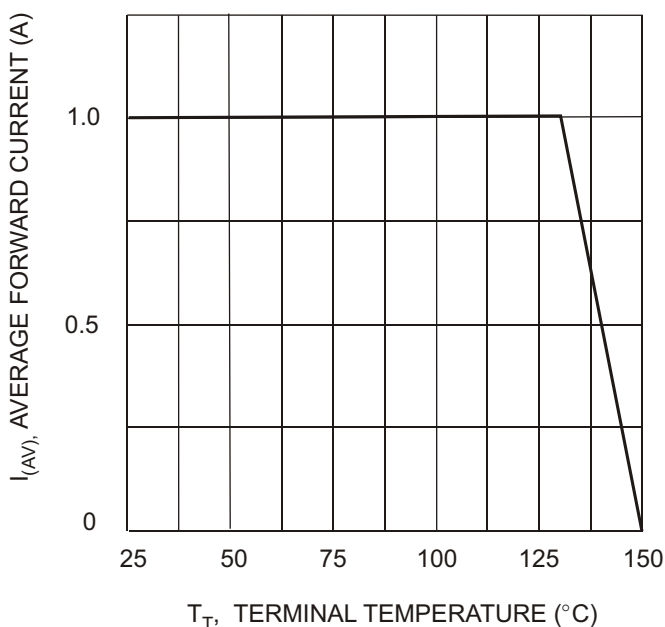


Fig. 1 Forward Current Derating Curve

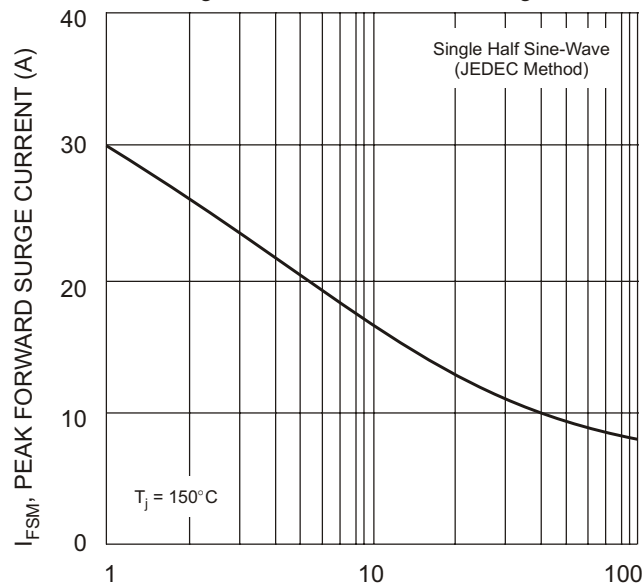


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

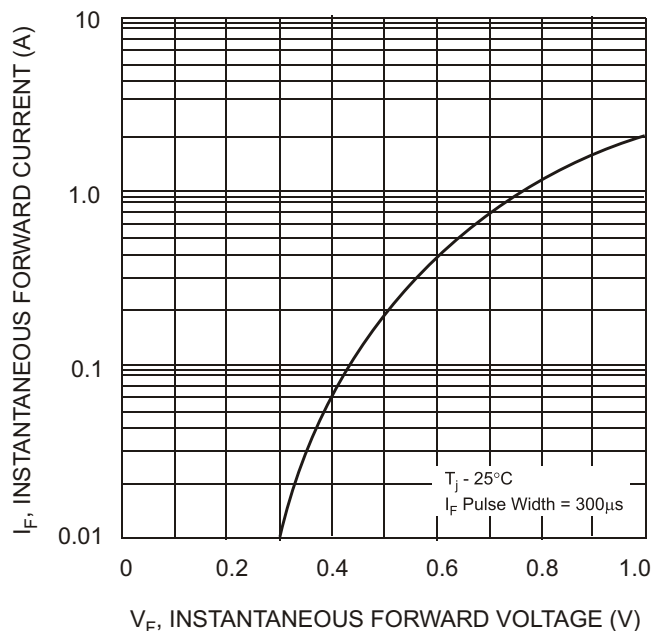


Fig. 2 Typical Forward Characteristics

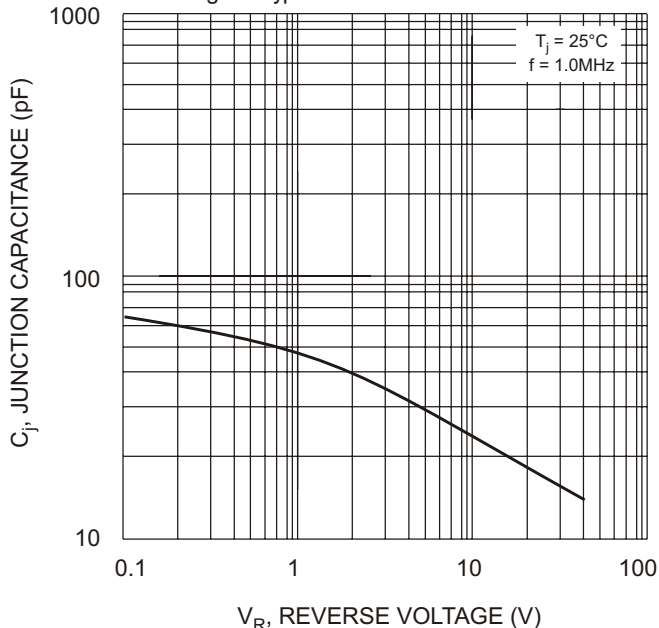


Fig. 4 Typical Junction Capacitance